

AMENDMENTS TO THE CLAIMS

Please amend claim 1 as follows:

1. (Previously presented) A process for fixing at least one balancing weight to at least one location on a hollow shaft, for torque transmission at rotational speeds in the range of 3000 rpm to 12000 rpm in a drive system for a vehicle, comprising securing the at least one balancing weight to the at least one location by soldering, wherein a solder for the soldering is applied as a foil, or brazing[[.]]

2-18. (Cancelled)

Please add the following new claims:

19. (New) A process according to Claim 1, wherein the at least one balancing weight is secured by soft soldering.

20. (New) A process according to Claim 19, wherein the hollow shaft, at the at least one location, does not exceed a maximum temperature of 450°C during soldering.

21. (New) A process according to Claim 1, wherein solder material without flux is used.

22. (New) A process according to Claim 1, wherein the soldering step at the at least one location lasts no longer than 3 seconds.

23. (New) A process according to Claim 20, wherein the soldering step at the at least one location lasts no longer than 3 seconds.

24. (New) A process according to Claim 21, wherein the soldering step at the at least one location lasts no longer than 3 seconds.

25. (New) A process according to Claim 1, wherein during soldering, a joining force of less than 2000 Newton is exerted on the at least one balancing weight towards the hollow shaft.

26. (New) A process according to Claim 20, wherein during soldering, a joining force of less than 2000 Newton is exerted on the at least one balancing weight towards the hollow shaft.

27. (New) A process according to Claim 1, wherein the at least one balancing weight is first provided with solder material and, thereafter, fixed to the hollow shaft.

28. (New) A process according to Claim 27, wherein a plurality of balancing weights are fixed, and at least in some cases, different quantities of solder material are provided at the balancing weights.

29. (New) A process according to Claim 1, wherein at least one of the following heat sources is used for the soldering step: inductor, convector.

30. (New) A process according to Claim 1, wherein at least the balancing of the hollow shaft and the soldering of the at least one balancing weight are carried out on a single machine.